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# **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

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Complete if Known

Application Number 10/812,053  
 Confirmation Number 1299  
 Filing Date March 30, 2004  
 First Named Inventor Shinichi NAGAOKA  
 Art Unit 1722  
 Examiner Name Unknown  
 Attorney Docket Number Q80741

## **U.S. PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code <sup>2</sup> (if known)		
		US			
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## **FOREIGN PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation <sup>6</sup>
		Country Code <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)			
/JH/		JP	2002-355866	A	12-10-2002	Daiwa Kasei Ind. Co., Ltd.	Abstract
/JH/		JP	08-118420	A	05-14-1996	Toyoda Gosei Co., Ltd.	Abstract
/JH/		JP	2001-277308	A	10-09-2001	Canon, Inc.	Abstract

## **NON PATENT LITERATURE DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation <sup>6</sup>
/JH/		NAGAOKA et al., "Application of CAO Technique to Injection Molding Analysis", V-212, June 13, 2003, with English Abstract	
/JH/		NAGAOKA et al., "Application of CAO Technique to Injection Molding Analysis", C217, November 4, 2003, with English Abstract	
/JH/		NAGAOKA et al., "New Method of Designing Runner System for Injection Mold Using CAO Technique", ANTEC 2004	

Examiner Signature

/Jill Heitbrink/ (03/30/2007)

Date Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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